MC74LCX74

Low-Voltage CMOS Dual D-Type Flip-Flop

With 5 V−Tolerant Inputs

The MC74LCX74 is a high performance, dual D−type flip−flop with asynchronous clear and set inputs and complementary (O, $\overline{O}$) outputs. It operates from a 2.3 to 3.6 V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A V_I specification of 5.5 V allows MC74LCX74 inputs to be safely driven from 5.0 V devices.

The MC74LCX74 consists of 2 edge−triggered flip−flops with individual D−type inputs. The flip−flop will store the state of individual D inputs, that meet the setup and hold time requirements, on the LOW−to−HIGH Clock (CP) transition.

Features

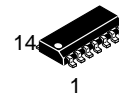- Designed for 2.3 V to 3.6 V V_{CC} Operation
- 5.0 V Tolerant Inputs – Interface Capability With 5.0 V TTL Logic
- LVTTL Compatible
- LVCMOS Compatible
- 24 mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current in All Three Logic States (10 µA) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 500 mA
- ESD Performance: Human Body Model >2000 V Machine Model >200 V
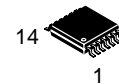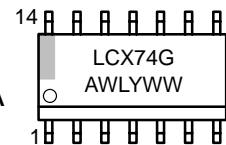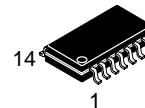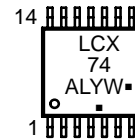- Pb−Free Packages are Available*

ON Semiconductor®

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MARKING DIAGRAMS

SOIC−14
D SUFFIX
CASE 751A

```
14
LCX74G
AWLYWW
1
```

TSSOP−14
DT SUFFIX
CASE 948G

```
14
LCX
74
ALYW■
1
```

SOEIAJ−14
M SUFFIX
CASE 965

```
14
74LCX74
ALYWG
1
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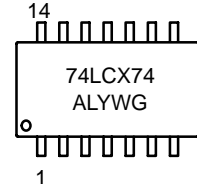
A	=	Assembly Location
L, WL	=	Wafer Lot
Y, YY	=	Year
W, WW	=	Work Week
G	=	Pb−Free Package
■	=	Pb−Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.
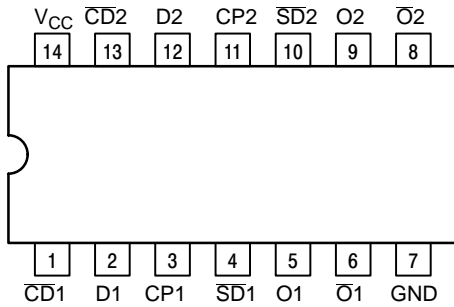
MC74LCX74

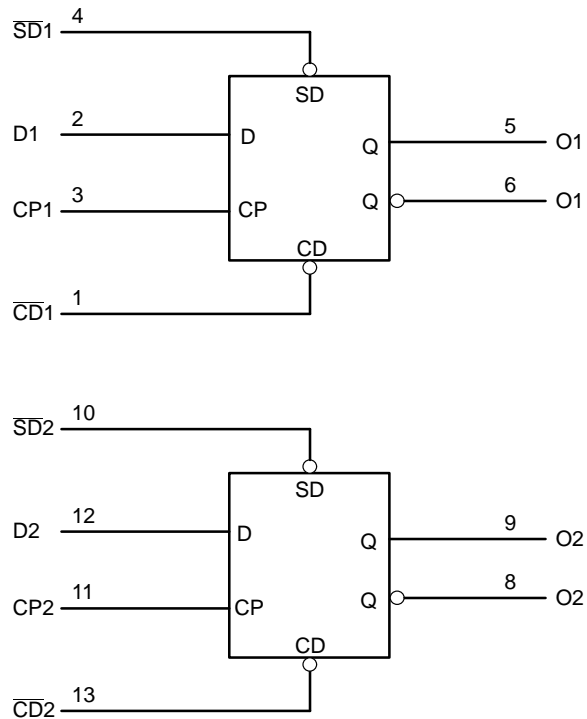**Figure 1. Pinout: 14–Lead (Top View)**

Figure 2. Logic Diagram

PIN NAMES

Pins	Function
CP1, CP2	Clock Pulse Inputs
D1–D2	Data Inputs
$\overline{CD}1$, $\overline{CD}2$	Direct Clear Inputs
$\overline{SD}1$, $\overline{SD}2$	Direct Set Inputs
On–$\overline{O}$n	Outputs

TRUTH TABLE

Inputs				Outputs		
$\overline{SD}$n	$\overline{CD}$n	CPn	Dn	On	$\overline{O}$n	Operating Mode
L	H	X	X	H	L	Asynchronous Set
H	L	X	X	L	H	Asynchronous Clear
L	L	X	X	H	H	Undetermined
H	H	↑	h	H	L	Load and Read Register
H	H	↑	l	L	H	Load and Read Register
H	H	↕	X	NC	NC	Hold

H = High Voltage Level
h = High Voltage Level One Setup Time Prior to the Low–to–High Clock Transition
L = Low Voltage Level
l = Low Voltage Level One Setup Time Prior to the Low–to–High Clock Transition
NC = No Change
X = High or Low Voltage Level and Transitions are Acceptable
↑ = Low–to–High Transition
↕ = Not a Low–to–High Transition

For I_{CC} reasons, DO NOT FLOAT Inputs

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MC74LCX74

MAXIMUM RATINGS

Symbol	Parameter	Value	Condition	Unit
V_{CC}	DC Supply Voltage	−0.5 to +7.0		V
V_I	DC Input Voltage	$−0.5 \leq V_I \leq +7.0$		V
V_O	DC Output Voltage	$−0.5 \leq V_O \leq V_{CC} + 0.5$	Output in HIGH or LOW State (Note 1)	V
I_{IK}	DC Input Diode Current	−50	V_I < GND	mA
I_{OK}	DC Output Diode Current	−50	V_O < GND	mA
		+50	$V_O > V_{CC}$	mA
I_O	DC Output Source/Sink Current	±50		mA
I_{CC}	DC Supply Current Per Supply Pin	±100		mA
I_{GND}	DC Ground Current Per Ground Pin	±100		mA
T_{STG}	Storage Temperature Range	−65 to +150		°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.
1. I_O absolute maximum rating must be observed.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Type	Max	Unit
V_{CC}	Supply Voltage	Operating Data Retention Only	2.0 1.5	2.5, 3.3 2.5, 3.3	3.6 3.6	V
V_I	Input Voltage		0		5.5	V
V_O	Output Voltage	(HIGH or LOW State) (3−State)	0		V_{CC}	V
I_{OH}	HIGH Level Output Current	V_{CC} = 3.0 V − 3.6 V V_{CC} = 2.7 V − 3.0 V V_{CC} = 2.3 V − 2.7 V			−24 −12 −8	mA
I_{OL}	LOW Level Output Current	V_{CC} = 3.0 V − 3.6 V V_{CC} = 2.7 V − 3.0 V V_{CC} = 2.3 V − 2.7 V			+24 +12 +8	mA
T_A	Operating Free−Air Temperature		−40		+85	°C
$\Delta t/\Delta V$	Input Transition Rise or Fall Rate, V_{IN} from 0.8 V to 2.0 V, V_{CC} = 3.0 V		0		10	ns/V

ORDERING INFORMATION

Device	Package	Shipping†
MC74LCX74D	SOIC−14	55 Units / Rail
MC74LCX74DG	SOIC−14 (Pb−Free)	55 Units / Rail
MC74LCX74DR2	SOIC−14	2500 Tape & Reel
MC74LCX74DR2G	SOIC−14 (Pb−Free)	2500 Tape & Reel
MC74LCX74DT	TSSOP−14*	96 Units / Rail
MC74LCX74DTG	TSSOP−14*	96 Units / Rail
MC74LCX74DTR2	TSSOP−14*	2500 Tape & Reel
MC74LCX74DTR2G	TSSOP−14*	2500 Tape & Reel
MC74LCX74MEL	SOEIAJ−14	2000 Tape & Reel
MC74LCX74MELG	SOEIAJ−14 (Pb−Free)	2000 Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*This package is inherently Pb−Free.

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DC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic	Condition	TA = −40°C to +85°C Min	TA = −40°C to +85°C Max	Unit
V_{IH}	HIGH Level Input Voltage (Note 2)	$2.3\ V \le V_{CC} \le 2.7\ V$	1.7		V
		$2.7\ V \le V_{CC} \le 3.6\ V$	2.0		
V_{IL}	LOW Level Input Voltage (Note 2)	$2.3\ V \le V_{CC} \le 2.7\ V$		0.7	V
		$2.7\ V \le V_{CC} \le 3.6\ V$		0.8	
V_{OH}	HIGH Level Output Voltage	$2.3\ V \le V_{CC} \le 3.6\ V$; $I_{OH} = -100\ \mu A$	$V_{CC} - 0.2$		V
		$V_{CC} = 2.3\ V$; $I_{OH} = -8\ mA$	1.8		
		$V_{CC} = 2.7\ V$; $I_{OH} = -12\ mA$	2.2		
		$V_{CC} = 3.0\ V$; $I_{OH} = -18\ mA$	2.4		
		$V_{CC} = 3.0\ V$; $I_{OH} = -24\ mA$	2.2		
V_{OL}	LOW Level Output Voltage	$2.3\ V \le V_{CC} \le 3.6\ V$; $I_{OL} = 100\ \mu A$		0.2	V
		$V_{CC} = 2.3\ V$; $I_{OL} = 8\ mA$		0.6	
		$V_{CC} = 2.7\ V$; $I_{OL} = 12\ mA$		0.4	
		$V_{CC} = 3.0\ V$; $I_{OL} = 16\ mA$		0.4	
		$V_{CC} = 3.0\ V$; $I_{OL} = 24\ mA$		0.55	
I_I	Input Leakage Current	$2.3\ V \le V_{CC} \le 3.6\ V$; $0\ V \le V_I \le 5.5\ V$		±5	μA
I_{CC}	Quiescent Supply Current	$2.3 \le V_{CC} \le 3.6\ V$; $V_I = GND$ or V_{CC}		10	μA
		$2.3 \le V_{CC} \le 3.6\ V$; $3.6 \le V_I$ or $V_O \le 5.5\ V$		±10	
ΔI_{CC}	Increase in I_{CC} per Input	$2.3 \le V_{CC} \le 3.6\ V$; $V_{IH} = V_{CC} - 0.6\ V$		500	μA

2. These values of V_I are used to test DC electrical characteristics only.

AC CHARACTERISTICS $t_R = t_F = 2.5$ ns; $R_L = 500\ \Omega$

Symbol	Parameter	Waveform	V_{CC} = 3.3 V ± 0.3 V, C_L = 50 pF Min	V_{CC} = 3.3 V ± 0.3 V, C_L = 50 pF Max	V_{CC} = 2.7 V, C_L = 50 pF Min	V_{CC} = 2.7 V, C_L = 50 pF Max	V_{CC} = 2.5 V ± 0.2 V, C_L = 30 pF Min	V_{CC} = 2.5 V ± 0.2 V, C_L = 30 pF Max	Unit
f_{max}	Clock Pulse Frequency	1	150		150		150		MHz
t_{PLH}	Propagation Delay	1	1.5	7.0	1.5	8.0	1.5	8.4	ns
t_{PHL}	CPn to On or $\overline{O}$n		1.5	7.0	1.5	8.0	1.5	8.4	
t_{PLH}	Propagation Delay	2	1.5	7.0	1.5	8.0	1.5	8.4	ns
t_{PHL}	$\overline{SD}$n or $\overline{CD}$n to On or $\overline{O}$n		1.5	7.0	1.5	8.0	1.5	8.4	
t_s	Setup Time, HIGH or LOW Dn to CPn	1	2.5		2.5		4.0		ns
t_h	Hold Time, HIGH or LOW Dn to CPn	1	1.5		1.5		2.0		ns
t_w	CPn Pulse Width, HIGH or LOW	4	3.3		3.3		4.0		ns
	$\overline{SD}$n or $\overline{CD}$n Pulse Width, LOW		3.3		3.6		4.0		ns
t_{rec}	Recovery Time $\overline{SD}$n or $\overline{CD}$n to CPn	3	2.5		3.0		4.5		ns
t_{OSHL}	Output−to−Output Skew			1.0					ns
t_{OSLH}	(Note 3)			1.0					

3. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH−to−LOW (t_{OSHL}) or LOW−to−HIGH (t_{OSLH}); parameter guaranteed by design.
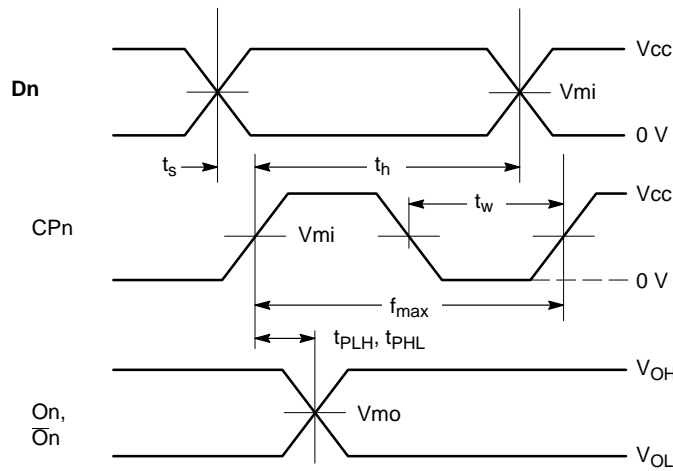
MC74LCX74

DYNAMIC SWITCHING CHARACTERISTICS

Symbol	Characteristic	Condition	Min	Typ	Max	Unit
V_{OLP}	Dynamic LOW Peak Voltage (Note 4)	V_{CC} = 3.3 V, C_L = 50 pF, V_{IH} = 3.3 V, V_{IL} = 0 V V_{CC} = 2.5 V, C_L = 30 pF, V_{IH} = 2.5 V, V_{IL} = 0 V		0.8 0.6		V V
V_{OLV}	Dynamic LOW Valley Voltage (Note 4)	V_{CC} = 3.3 V, C_L = 50 pF, V_{IH} = 3.3 V, V_{IL} = 0 V V_{CC} = 2.5 V, C_L = 30 pF, V_{IH} = 2.5 V, V_{IL} = 0 V		−0.8 −0.6		V V

T_A = +25°C

4. Number of outputs defined as "n". Measured with "n−1" outputs switching from HIGH–to–LOW or LOW–to–HIGH. The remaining output is measured in the LOW state.

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Typical	Unit
C_{IN}	Input Capacitance	V_{CC} = 3.3 V, V_I = 0 V or V_{CC}	7	pF
C_{OUT}	Output Capacitance	V_{CC} = 3.3 V, V_I = 0 V or V_{CC}	8	pF
C_{PD}	Power Dissipation Capacitance	10 MHz, V_{CC} = 3.3 V, V_I = 0 V or V_{CC}	25	pF

WAVEFORM 1 – PROPAGATION DELAYS, SETUP AND HOLD TIMES
$t_R = t_F$ = 2.5 ns, 10% to 90%; f = 1 MHz; t_W = 500 ns
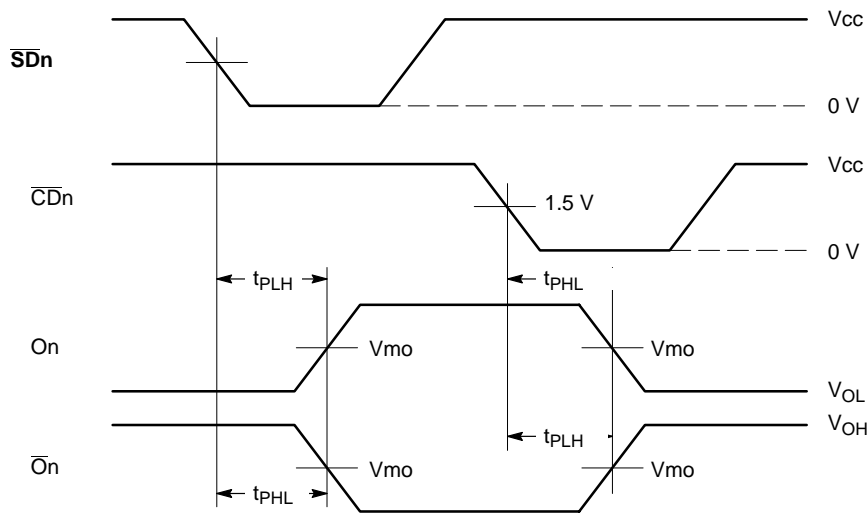
WAVEFORM 2 – PROPAGATION DELAYS
$t_R = t_F$ = 2.5 ns, 10% to 90%; f = 1 MHz; t_W = 500 ns
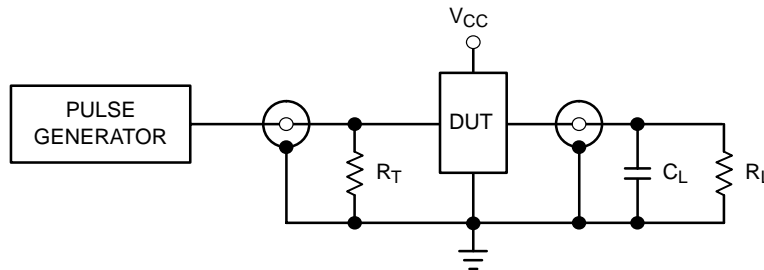
Figure 3. AC Waveforms

MC74LCX74
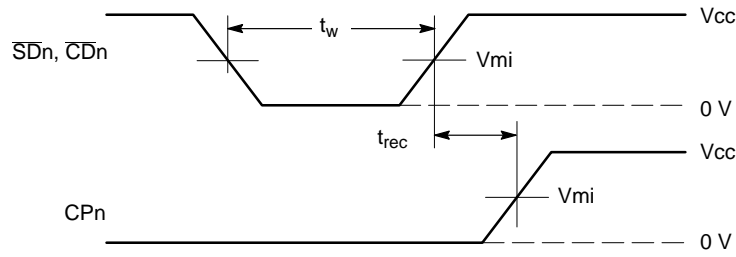
WAVEFORM 3 – RECOVERY TIME
$t_R = t_F = 2.5$ ns from 10% to 90%; f = 1 MHz; $t_w = 500$ ns
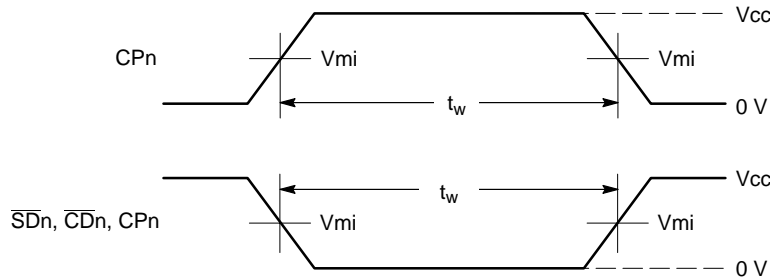
WAVEFORM 4 – PULSE WIDTH
$t_R = t_F = 2.5$ ns (or fast as required) from 10% to 90%;
Output requirements: $V_{OL} \leq 0.8$ V, $V_{OH} \geq 2.0$ V

Symbol	Vcc		
	3.3 V $\pm$ 0.3 V	2.7 V	2.5 V $\pm$ 0.2 V
Vmi	1.5 V	1.5 V	Vcc/2
Vmo	1.5 V	1.5 V	Vcc/2

Figure 3. AC Waveforms (Continued)

C_L = 50 pF at V_{CC} = 3.3 $\pm$ 0.3 V or equivalent (includes jig and probe capacitance)
C_L = 30 pF at V_{CC} = 2.5 $\pm$ 0.2 V or equivalent (includes jig and probe capacitance)
R_L = R_1 = 500 Ω or equivalent
R_T = Z_{OUT} of pulse generator (typically 50 Ω)

Figure 4. Test Circuit

PACKAGE DIMENSIONS

SOIC–14
D SUFFIX
CASE 751A–03
ISSUE G
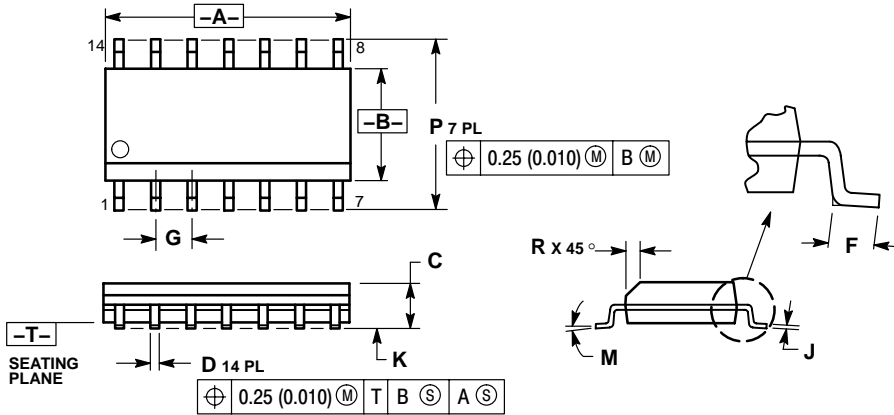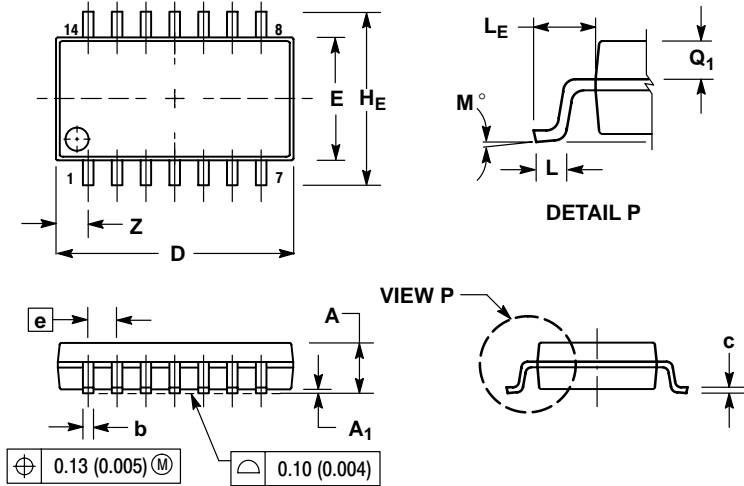

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0 °	7 °	0 °	7 °
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

TSSOP–14
DT SUFFIX
CASE 948G–01
ISSUE A
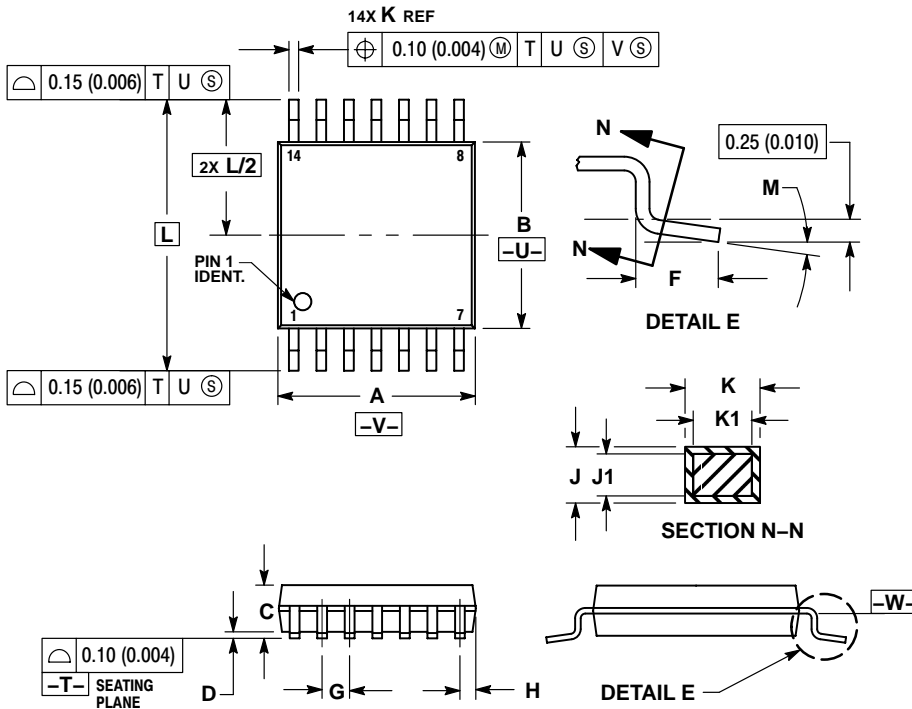
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE –W–.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	–––	1.20	–––	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0 °	8 °	0 °	8 °

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PACKAGE DIMENSIONS

SOEIAJ–14
M SUFFIX
CASE 965–01
ISSUE O

DETAIL P

VIEW P

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	---	2.05	---	0.081
A$_1$	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.18	0.27	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H$_E$	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
L$_E$	1.10	1.50	0.043	0.059
M	0 °	10 °	0 °	10 °
Q$_1$	0.70	0.90	0.028	0.035
Z	---	1.42	---	0.056

MC74LCX74/D